



#### COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

#### **Product Summary**

Device	BV <sub>DSS</sub>	R <sub>DS(ON)</sub> max	I <sub>D</sub> max T <sub>A</sub> = +25°C
04		$25m\Omega$ @ V <sub>GS</sub> = 4.5V	6.0A
Q1 N-Channel	12V	$30m\Omega$ @ V <sub>GS</sub> = 3.3V	5.5A
N-Charmer		$32m\Omega$ @ $V_{GS} = 2.5V$	5.3A
00		$80m\Omega @ V_{GS} = -4.5V$	-3.4A
Q2 P-Channel	-20V	90mΩ @ V <sub>GS</sub> = -3.3V	-3.2A
1 - Onamici		100mΩ @ V <sub>GS</sub> = -2.5V	-3.0A

#### **Features**

- Low On-Resistance
- Low Input Capacitance
- Low Profile, 0.6mm Max Height
- ESD HBM Protected up to 1.5kV, MM Protected up to 150V
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

### **Description**

This MOSFET is designed to minimize the on-state resistance (RDS(ON)) and yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

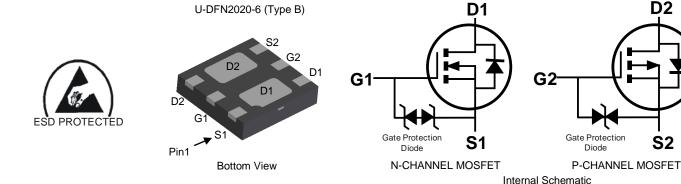
### **Applications**

Optimized for Point of Load (POL) Synchronous Buck Converter that steps down from 3.3V to 1V for core voltage supply to ASICs. Target applications are Ethernet Network Controllers used in:

- Routers, Switchers, Network Interface Controllers (NICs)
- Digital Subscriber Line (DSL)
- Set-Top Boxes (STBs)

#### **Mechanical Data**

- Case: U-DFN2020-6
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (4)
- Terminals Connections: See Diagram Below
- Weight: 0.0065 grams (Approximate)



### **Ordering Information** (Note 4)

Part Number	Case	Packaging
DMC1028UFDB-7	U-DFN2020-6 (Type B)	3,000/Tape & Reel
DMC1028UFDB-13	U-DFN2020-6 (Type B)	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

**D2** 

S2



### **Marking Information**

Site 1



D8 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: H = 2020) M = Month (ex: 9 = September)

Date Code Key

Year	2014		2020	2021	2022	2023	2024	2025	2026	2027	2028	2029
Code	В		Н		J	K	L	М	Ν	0	Р	R
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec

Site 2



D8 = Product Type Marking Code
YWX = Date Code Marking
Y = Year (ex: 0 = 2020)
W = Week (ex: a = Week 27; z Represents Week 52 and 53)
X = Internal Code (ex: U = Monday)

Date Code Key

Year	2014		2020	2021	2022	2023	2024	2025	2026	2027	2028	2029
Code	4		0	1	2	3	4	5	6	7	8	9
Week	Week 1-26			27-52				53				
Code		А	-Z		a-z				Z			
Internal Code	Sur	1	Mon		Tue	W	ed	Thu		Fri	;	Sat
Code	Т		U		V	V	٧	Х		Υ		Z



#### **Maximum Ratings** (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Q1 N-CHANNEL	Q2 P-CHANNEL	Unit		
Drain-Source Voltage			VDSS	12	-20	V
Gate-Source Voltage			Vgss	±8	±8	V
Continuous Drain Current (Note 5) N-Channel: V <sub>GS</sub> = 4.5V	Steady State	$T_A = +25$ °C $T_A = +70$ °C	I <sub>D</sub>	6.0 4.8	-3.4 -2.7	А
P-Channel: V <sub>GS</sub> = 4.5V	t < 5s	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	ID	7.1 5.7	-4.0 -3.2	А
Maximum Continuous Body Diode Forward Cur	rent (Note 5	)	Is	1.4	-1.4	А
Pulsed Drain Current (10µs Pulse, Duty Cycle =	I <sub>DM</sub>	40	-20	Α		
Avalanche Current L = 0.1mH	las	12	-12	А		
Avalanche Energy L = 0.1mH			E <sub>AS</sub>	8.4	7.5	mJ

### **Thermal Characteristics**

Characteristic	Symbol	Value	Unit		
Total Power Dissipation (Note 5)	Steady State	PD	1.36	W	
Total Fower Dissipation (Note 3)	t < 5s	FD	1.89	VV	
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	D	92		
Thermal Resistance, Junction to Ambient (Note 5)	t < 5s	R <sub>θ</sub> ЈА	66	°C/W	
Thermal Resistance, Junction to Case (Note 5)	Rejc	19			
Operating and Storage Temperature Range	T <sub>J,</sub> T <sub>STG</sub>	-55 to +150	°C		

5. Device mounted on 1" × 1" FR-4 PCB with high coverage 2oz. Copper, single sided. Note:

### Electrical Characteristics Q1 N-CHANNEL (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 6)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	12	l	_	V	$V_{GS} = 0V, I_{D} = 250\mu A$	
Zero Gate Voltage Drain Current TJ = +25°C	IDSS	1	1	1.0	μΑ	V <sub>DS</sub> = 12V, V <sub>GS</sub> = 0V	
Gate-Source Leakage	Igss	_	_	±10	μΑ	$V_{GS} = \pm 8V$ , $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 6)							
Gate Threshold Voltage	Vgs(TH)	0.4	_	1	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$	
		l	17	25		$V_{GS} = 4.5V, I_{D} = 5.2A$	
Static Drain-Source On-Resistance	Dagger	I	19	30	mΩ	$V_{GS} = 3.3V, I_{D} = 5.0A$	
Static Dialit-Source Off-Resistance	RDS(ON)	_	21	32	11152	$V_{GS} = 2.5V, I_{D} = 4.8A$	
		1	30	40		$V_{GS} = 1.8V, I_D = 2.5A$	
Diode Forward Voltage	VsD	_	0.7	1.2	V	V <sub>G</sub> S = 0V, I <sub>S</sub> = 1A	
DYNAMIC CHARACTERISTICS (Note 7)							
Input Capacitance	Ciss		787	_	pF	\/	
Output Capacitance	Coss	_	203	_	pF	$V_{DS} = 6V, V_{GS} = 0V,$ -f = 1.0MHz	
Reverse Transfer Capacitance	Crss	1	177	_	pF	1 = 1.001112	
Gate Resistance	Rg	_	4.8	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge (V <sub>GS</sub> = 3.3V)		_	7.9	_	nC		
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	_	10.5	_	nC		
Total Gate Charge (V <sub>GS</sub> = 8V)		_	18.5	_	nC	$V_{DS} = 6V, I_{D} = 6.8A$	
Gate-Source Charge	Qgs	_	1.2	_	nC	]	
Gate-Drain Charge	Qgd	_	2.9	_	nC		
Turn-On Delay Time	t <sub>D(ON)</sub>	_	4.6	_	ns		
Turn-On Rise Time	t <sub>R</sub>	_	9.4	_	ns	$V_{DD} = 6V, V_{GS} = 4.5V,$	
Turn-Off Delay Time	tD(OFF)	_	15.7	_	ns	$R_L = 1.1\Omega$ , $R_G = 1\Omega$	
Turn-Off Fall Time	t <sub>F</sub>	_	3.7	_	ns	]	
Body Diode Reverse Recovery Time	trr	-	12.0	_	ns	Is = 5.4A, dI/dt = 100A/µs	
Body Diode Reverse Recovery Charge	$Q_{RR}$	_	1.8	_	nC	I <sub>S</sub> = 5.4A, dI/dt = 100A/µs	

6. Short duration pulse test used to minimize self-heating effect. 7. Guaranteed by design. Not subject to product testing. Notes:



# Electrical Characteristics Q2 P-CHANNEL (@TA = +25°C, unless otherwise specified.)

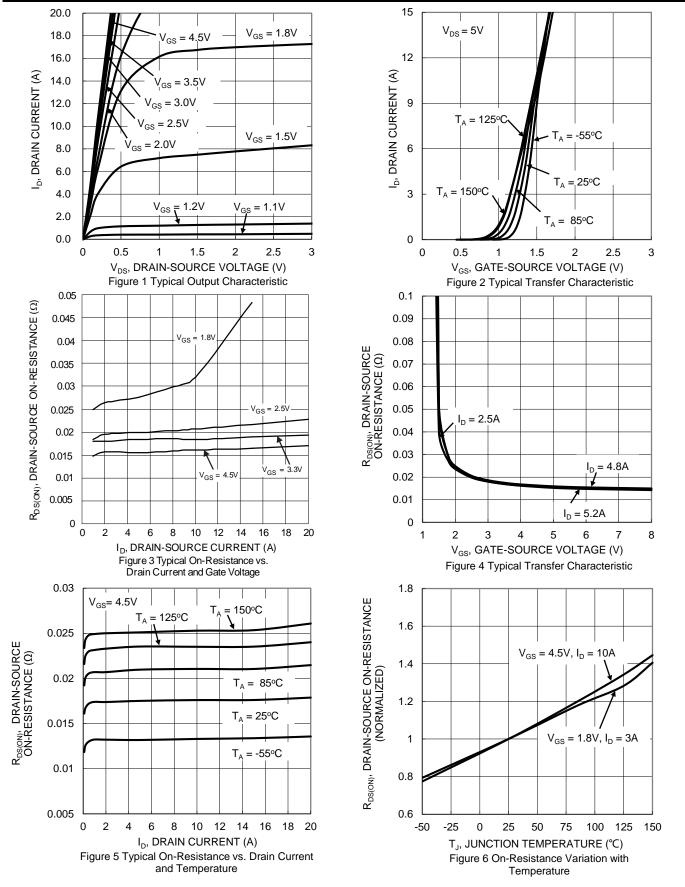
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition		
OFF CHARACTERISTICS (Note 6)	_							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-20	_	_	V	$V_{GS} = 0V, I_D = -250\mu A$		
Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C	IDSS	_	_	-1.0	μΑ	V <sub>DS</sub> = -20V, V <sub>GS</sub> = 0V		
Gate-Source Leakage	Igss	_	_	±10	μΑ	$V_{GS} = \pm 8V$ , $V_{DS} = 0V$		
ON CHARACTERISTICS (Note 6)								
Gate Threshold Voltage	Vgs(TH)	-0.4	-	-1	V	$V_{DS} = V_{GS}$ , $I_D = -250\mu A$		
		_	55	80		$V_{GS} = -4.5V$ , $I_{D} = -3.8A$		
		l	63	90		$V_{GS} = -3.3V$ , $I_{D} = -3.5A$		
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	_	70	100	mΩ	$V_{GS} = -2.5V$ , $I_{D} = -3.3A$		
		_	88	140		$V_{GS} = -1.8V, I_{D} = -1.0A$		
		_	110	210		$V_{GS} = -1.5V, I_{D} = -0.5A$		
Diode Forward Voltage	VsD	_	-0.7	-1.2	V	Vgs = 0V, Is = -1A		
DYNAMIC CHARACTERISTICS (Note 7)								
Input Capacitance	Ciss	_	576	_	pF	101/11/		
Output Capacitance	Coss	_	87	_	pF	V <sub>DS</sub> = -10V, V <sub>GS</sub> = 0V, -1f = 1.0MHz		
Reverse Transfer Capacitance	Crss	_	71	_	pF	1 = 1.0WH 12		
Gate Resistance	Rg	_	15	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$		
Total Gate Charge (Vgs = -3.3V)		_	5.2	_	nC			
Total Gate Charge (V <sub>GS</sub> = -4.5V)	$Q_g$	_	6.7	_	nC			
Total Gate Charge (Vgs = -8V)	-	_	11.5	_	nC	$V_{DS} = -10V, I_{D} = -4.9A$		
Gate-Source Charge	Qgs	_	1.0	_	nC			
Gate-Drain Charge	Qgd	_	2.0	_	nC			
Turn-On Delay Time	tD(ON)	_	3.5	_	ns			
Turn-On Rise Time	t <sub>R</sub>	_	3.6	_	ns	$V_{DD} = -10V, V_{GS} = -4.5V,$		
Turn-Off Delay Time	tD(OFF)	_	20.8	_	ns	$R_L = 2.6\Omega$ , $R_G = 1\Omega$		
Turn-Off Fall Time	t <sub>F</sub>	_	12.7	_	ns	7		
Body Diode Reverse Recovery Time	trr	_	13.1	_	ns	Is = -3.9A, dI/dt = 100A/µs		
Body Diode Reverse Recovery Charge	Q <sub>RR</sub>	_	3.9	_	nC	Is = -3.9A, dI/dt = 100A/µs		

Notes:

<sup>6.</sup> Short duration pulse test used to minimize self-heating effect. 7. Guaranteed by design. Not subject to product testing.



# **Typical Characteristics - N-CHANNEL**





### Typical Characteristics - N-CHANNEL (continued)

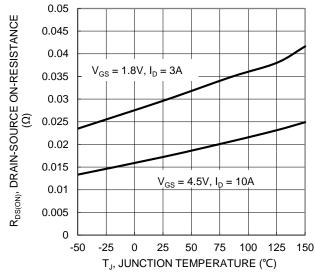


Figure 7 On-Resistance Variation with Temperature

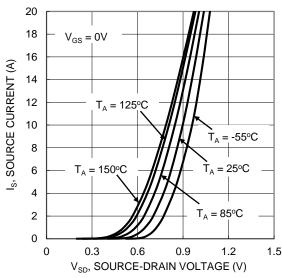
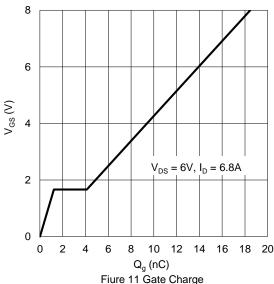
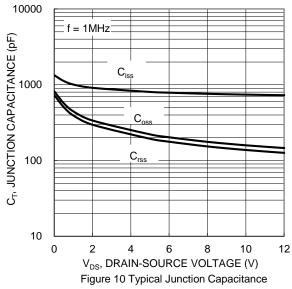


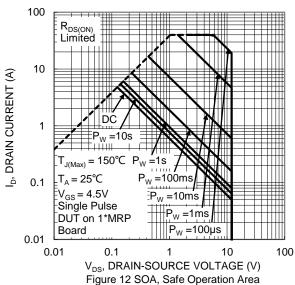
Figure 9 Diode Forward Voltage vs. Current



1.2  $V_{GS(TH)}$ , GATE THRESHOLD VOLTAGE (V) 1.1 1 0.9 8.0  $I_D = 1mA$ 0.7 0.6 0.5  $I_{D} = 250 \mu A$ 0.4 0.3 0.2 0.1 0 25 50 75 100 125  $T_J$ , JUNCTION TEMPERATURE (°C)

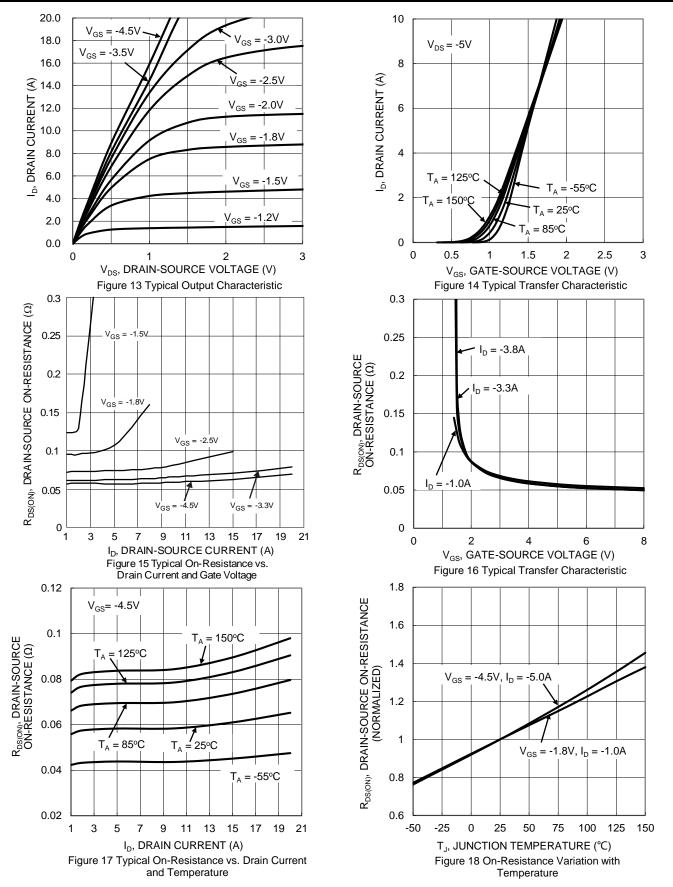
Figure 8 Gate Threshold Variation vs. Junction Temperature





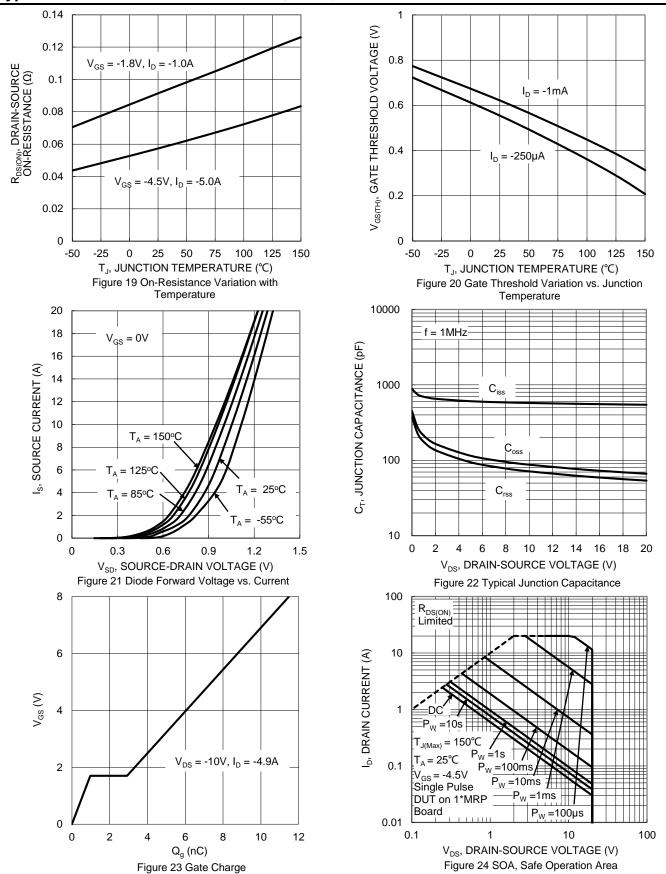


# **Typical Characteristics - P-CHANNEL**





### Typical Characteristics - P-CHANNEL (continued)





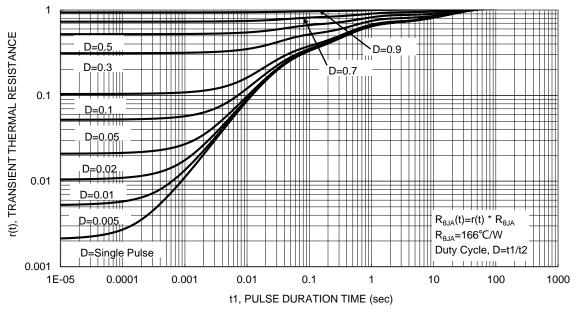
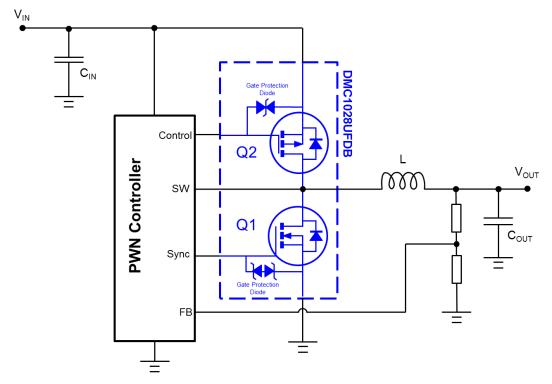


Figure 25 Transient Thermal Resistance

# **Typical Application Circuit**



Example of a 3.3V to 1V POL Buck Converter using the DMC1028UFDB

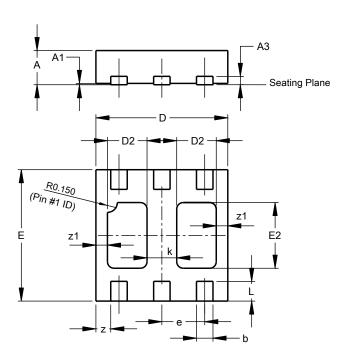
DMC1028UFDB is designed for Point-of-Load (POL) converter that is stepping down from a nominal 3.3V to 1V with a load current up to 3A. This is implemented with a separate ASIC that is PWM signaling the complementary MOSFETs to act as a synchronous buck converter. The control switch (Q2) is implemented with P-channel MOSFETs to avoid needing a charge pump and with the 3.3V to 1V step down, which has a duty cycle of 33%. This means that for 67% of the cycle, the synchronous switch (Q1) is on and efficiency is dominated by the conduction losses; hence, the need for low R<sub>DS(ON)</sub> N-channel MOSFETs. Whereas for the control switch (Q2), the gate charge needs to be minimized as the switching losses become significant.



### **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### U-DFN2020-6 (Type B)

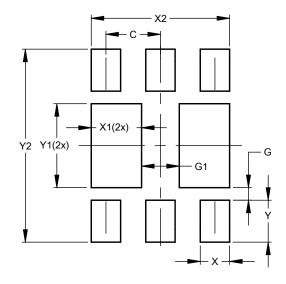


	U-DFN2020-6							
Type B								
Dim	Min	Max	Тур					
Α	0.545	0.605	0.575					
A1	0.00	0.05	0.02					
A3	-	-	0.13					
b	0.20	0.30	0.25					
D	1.95	2.075	2.00					
D2	0.50	0.70	0.60					
е	-	-	0.65					
Е	1.95	2.075	2.00					
E2	0.90	1.10	1.00					
k	-	-	0.45					
L	0.25	0.35	0.30					
Z	-	-	0.225					
z1	-	-	0.175					
All	Dimens	ions in	mm					

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### U-DFN2020-6 (Type B)



Dimensions	Value (in mm)
С	0.650
G	0.150
G1	0.450
Х	0.350
X1	0.600
X2	1.650
Υ	0.500
Y1	1.000
Y2	2 300



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